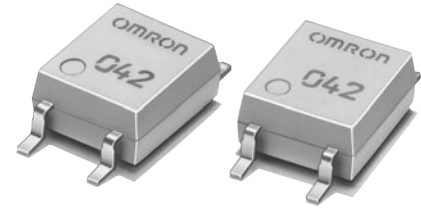# G3VM−61GR1

MOS FET Relays

MOS FET Relays with 1-A switching Designed for Switching Minute Signals and Analog Signals.

- Upgraded G3VM-S1 Series.
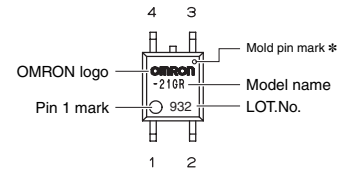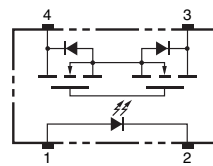- Continuous load current of 1 A.

RoHS compliant

Note: The actual product is marked differently from the image shown here.

■ Application Examples

- Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Data loggers

■ Terminal Arrangement/Internal Connections

OMRON logo
Pin 1 mark

Mold pin mark ✳
Model name
LOT.No.

Note: The actual product is marked differently from the image shown here.
✳ The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) ✳	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
SOP4	1a (SPST-NO)	Surface-mounting Terminals	60 V	G3VM-61GR1	100	-
				G3VM-61GR1 (TR)	-	2,500

✳ The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	I_F	50	mA	
	Repetitive peak LED forward current	I_{FP}	1	A	100 μs pulses, 100 pps
	LED forward current reduction rate	$\Delta I_F/°C$	−0.5	mA/°C	Ta ≥ 25°C
	LED reverse voltage	V_R	5	V	
	Connection temperature	T_J	125	°C	
Output	Load voltage (AC peak/DC)	V_{OFF}	60	V	
	Continuous load current (AC peak/DC)	I_O	1000	mA	
	ON current reduction rate	$\Delta I_O/°C$	−13.3	mA/°C	Ta ≥ 25°C
	Connection temperature	T_J	125	°C	
Dielectric strength between I/O (See note 1.)		V_{I-O}	1500	Vrms	AC for 1 min
Ambient operating temperature		Ta	−20 to +85	°C	With no icing or condensation
Ambient storage temperature		Tstg	−40 to +125	°C	With no icing or condensation
Soldering temperature		-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■ Electrical Characteristics (Ta = 25°C)

	Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	V_F	1.0	1.15	1.3	V	I_F = 10 mA
	Reverse current	I_R	-	-	10	μA	V_R = 5 V
	Capacity between terminals	C_T	-	15	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	I_{FT}	-	1.0	3	mA	I_O = 100 mA
Output	Maximum resistance with output ON	R_{ON}	-	0.25	0.7	Ω	I_F = 5 mA, I_O = 1 A
	Current leakage when the relay is open	I_{LEAK}	-	0.2	100	nA	V_{OFF} = 60 V
	Capacity between terminals	C_{off}	-	90	-	pF	V = 0, f = 1 MHz
Capacity between I/O terminals		C_{I-O}	-	0.8	-	pF	f = 1 MHz, V_S = 0 V
Insulation resistance between I/O terminals		R_{I-O}	1000	-	-	MΩ	V_{I-O} = 500 VDC, RoH ≤ 60 %
Turn-ON time		t_{ON}	-	1.4	3.0	ms	I_F = 5 mA, R_L = 200 Ω, V_{DD} = 20 V (See note 2.)
Turn-OFF time		t_{OFF}	-	0.6	1.0	ms	

Note: 2. Turn-ON and Turn-OFF Times

G3VM−61GR1
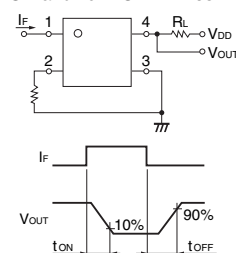
■Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	-	-	48	V
Operating LED forward current	I_F	5	10	20	mA
Continuous load current (AC peak/DC)	I_O	-	-	1000	mA
Ambient operating temperature	Ta	25	-	60	°C

■Engineering Data

LED forward current vs. Ambient temperature

I_F - Ta
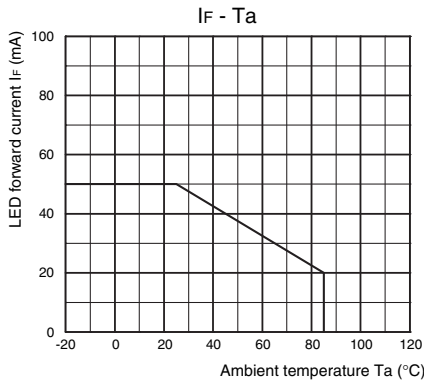
Continuous load current vs. Ambient temperature

I_O - Ta
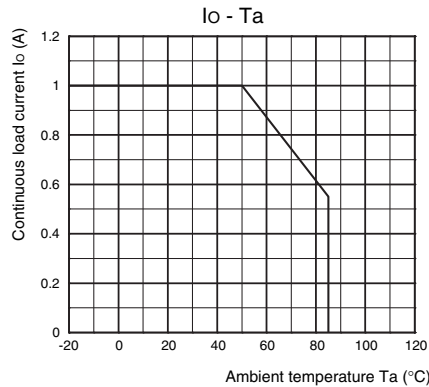
LED forward current vs. LED forward voltage

I_F - V_F
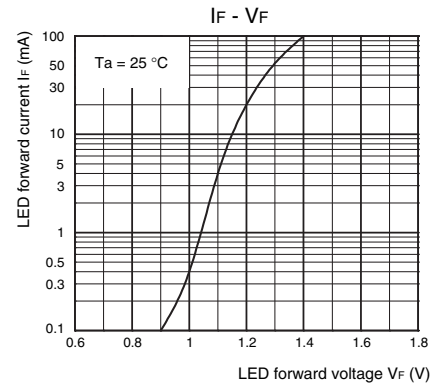
Continuous load current vs. On-state voltage

I_O - V_{ON}
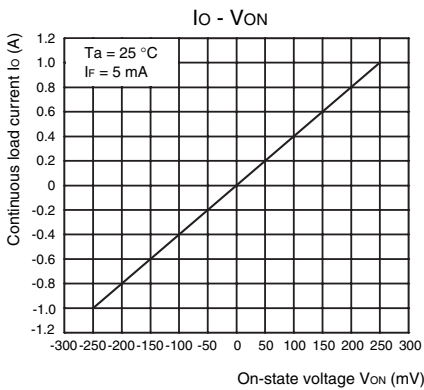
On-state resistance vs. Ambient temperature

R_{ON} - Ta

Trigger LED forward current vs. Ambient temperature

I_{FT} - Ta
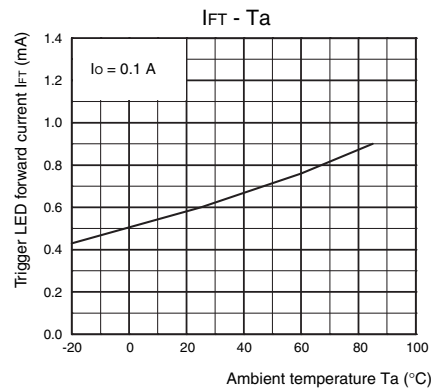
Turn ON, Turn OFF time vs. LED forward current

t_{ON}, t_{OFF} - I_F
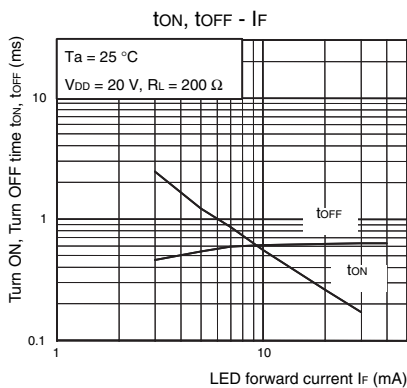
Turn ON, Turn OFF time vs. Ambient temperature

t_{ON}, t_{OFF} - Ta
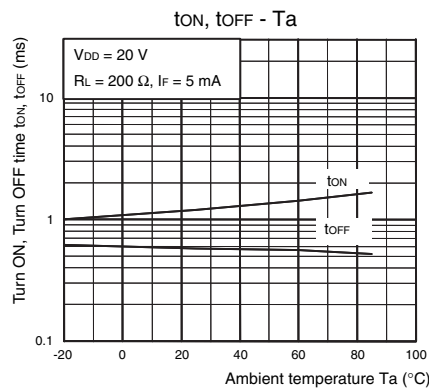
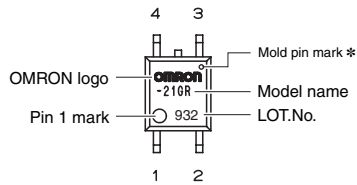**Current leakage vs. Ambient temperature**

I_{LEAK} - Ta
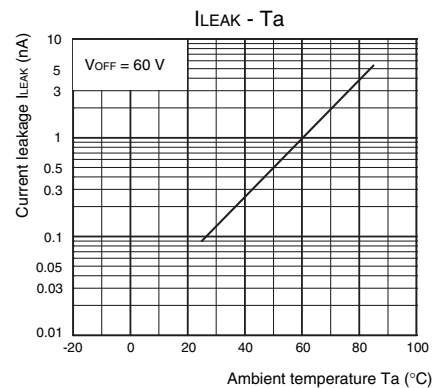
■Safety Precautions

• Refer to **"Common Precautions"** for all G3VM models.

■ Appearance

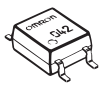SOP (Small Outline Package)
SOP4

Note: The actual product is marked differently from the image shown here.

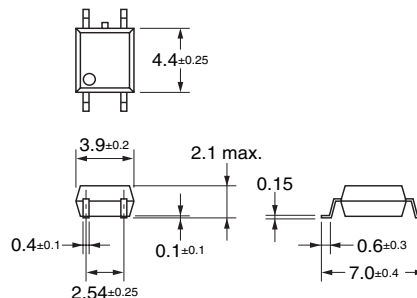✻ The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.
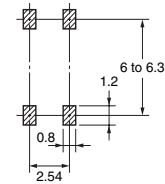
■ Dimensions

(Unit: mm)

Surface-mounting Terminals

Weight: 0.1 g

4.4±0.25

3.9±0.2

2.1 max.

0.15

0.4±0.1

0.1±0.1

2.54±0.25

0.6±0.3

7.0±0.4

Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)

6 to 6.3

1.2

0.8

2.54

Note: The actual product is marked differently from the image shown here.

- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

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